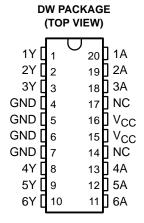
- Replaces 74AC11203
- Low-Skew Propagation Delay Specifications for Clock Driver Applications
- Operates at 3.3-V V_{CC}
- Flow-Through Architecture Optimizes PCB Layout
- Center-Pin V_{CC} and GND Pin Configurations Minimize High-Speed Switching Noise
- EPIC[™] (Enhanced-Performance Implanted CMOS) 1-μm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Packaged in Plastic Small-Outline Package



NC - No internal connection

description

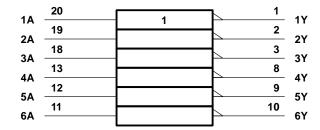
The CDC203 contains six independent inverters. The device performs the Boolean function $Y = \overline{A}$. It is designed specifically for applications requiring low skew between switching outputs.

The CDC203 is characterized for operation from 25°C to 70°C.

FUNCTION TABLE

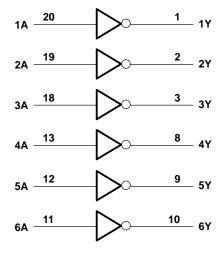
INPUT	OUTPUT
Α	Υ
Н	L
L	Н

logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

EPIC is a trademark of Texas Instruments Incorporated.



SCAS324A - OCTOBER 1989 - REVISED NOVEMBER 1995

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	0.5 V to 7 V
Input voltage range, V _I (see Note 1)	\sim 0.5 V to V _{CC} + 0.5 V
Output voltage range, VO (see Note 1)	\sim 0.5 V to V _{CC} + 0.5 V
Input clamp current, $I_{ K }(V_1 < 0 \text{ or } V_1 > V_{CC})$	±20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC})	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±50 mA
Continuous current through V _{CC} or GND	±150 mA
Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 2)	1.6 W
Storage temperature range, T _{stq}	−65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

recommended operating conditions

			MIN	NOM	MAX	UNIT
VCC	Supply voltage		3	3.3	3.6	V
V	High-level input voltage	V _{CC} = 3 V	2.1			V
۷IH		V _{CC} = 3.6 V	2.5			v
VIL	Low-level input voltage	V _{CC} = 3 V			0.9	V
		V _{CC} = 3.6 V			1.1	
٧ _I	Input voltage		0		VCC	V
٧o	Output voltage		0		VCC	V
1	High-level output current	V _{CC} = 3 V			-12	A
VI		V _{CC} = 3.6 V			-12	mA
la.	Lour lovel output outront	V _{CC} = 3 V			12	A
IOL	Low-level output current	V _{CC} = 3.6 V			12	mA
$\Delta t/\Delta v$	Input transition rise or fall rate		0		10	ns/V
f _{clock}	Input clock frequency				40	MHz
T _A	Operating free-air temperature		25		70	°C



^{2.} The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the *Package Thermal Considerations* application note in the 1994 *ABT Advanced BiCMOS Technology Data Book*, literature number SCBD002B.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

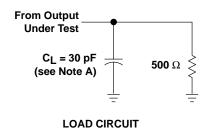
PARAMETER	TEST CONDITIONS	v _{CC}	TA = 25°C			MIN	MAX	UNIT	
PARAMETER			MIN	TYP	MAX	IVIIIV	WAA	UNIT	
	I _{OH} = -50 μA	3 V	2.9			2.9		· v	
VOH		3.6 V	3.5			3.5			
VOH VOH	I _{OH} = - 12 mA	3 V	2.58			2.48			
		3.6 V	3.18			3.08			
	Ι _Ο L = 50 μΑ	3 V			0.1		0.1	V	
Val		3.6 V			0.1		0.1		
VOL	I _{OL} = 12 mA	3 V			0.36		0.44		
	IOL = 12 IIIA	3.6 V			0.36		0.44		
lı	$V_I = V_{CC}$ or GND	3.6 V			±0.1		±1	μΑ	
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	3.6 V			4		40	μΑ	
Ci	$V_I = V_{CC}$ or GND	3.3 V		4				pF	

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (see Note 3 and Figures 1 and 2)

PARAMETER	PARAMETER FROM (INPUT)		MIN	MAX	UNIT
t _{PLH}	А А	V	3.5	6.1	ns
^t PHL		ī	3.5	6.1	
tsk(o)	А	Υ		0.7	ns

NOTE 3: All specifications are valid only for all outputs switching in phase simultaneously.

PARAMETER MEASUREMENT INFORMATION



Input (see Note B) 50% 50% 0 V tPLH VOH 50% VCC 50% VCC VOL

VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES

NOTES: A. C_L includes probe and jig capacitance.

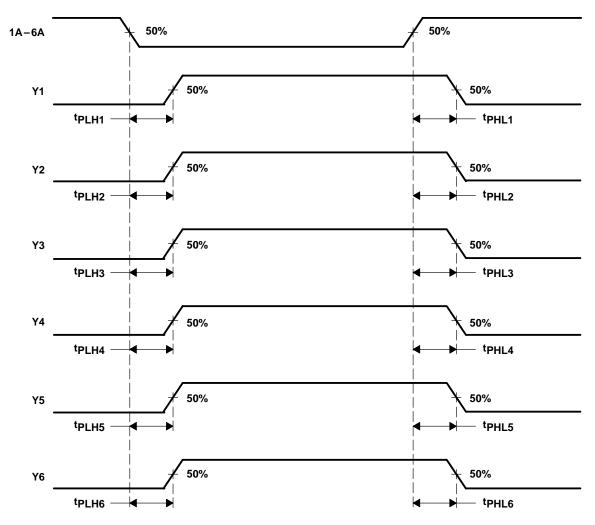
B. Input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_f = 3 \text{ ns}$, $t_f = 3 \text{ ns}$.

C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



PARAMETER MEASUREMENT INFORMATION



- NOTE A: Output skew, $t_{sk(o)}$, is calculated as the greater of:

 The difference between the fastest and slowest of t_{PLHn} (n = 1, 2, ..., 6)

 The difference between the fastest and slowest of t_{PHLn} (n = 1, 2, ..., 6)

Figure 2. Waveforms for Calculation of $t_{\rm Sk(0)}$

IMPORTANT NOTICE

Texas Instruments (TI) reserves the right to make changes to its products or to discontinue any semiconductor product or service without notice, and advises its customers to obtain the latest version of relevant information to verify, before placing orders, that the information being relied on is current.

TI warrants performance of its semiconductor products and related software to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

Certain applications using semiconductor products may involve potential risks of death, personal injury, or severe property or environmental damage ("Critical Applications").

TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, INTENDED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT APPLICATIONS, DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS.

Inclusion of TI products in such applications is understood to be fully at the risk of the customer. Use of TI products in such applications requires the written approval of an appropriate TI officer. Questions concerning potential risk applications should be directed to TI through a local SC sales office.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards should be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein. Nor does TI warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used.

Copyright © 1996, Texas Instruments Incorporated